

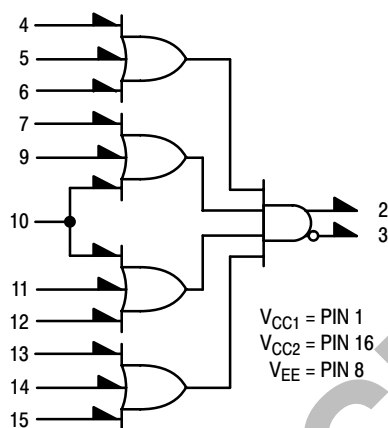
MC10121

4-Wide OR-AND/OR-AND Gate

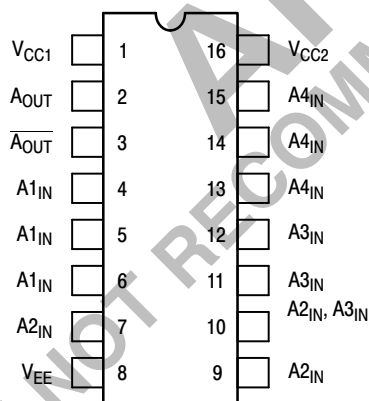
The MC10121 is a basic logic building block providing the simultaneous OR-AND/OR-AND-Invert function, useful in data control and digital multiplexing applications.

- $P_D = 100 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 2.3 \text{ ns typ}$
- $t_r, t_f = 2.5 \text{ ns typ (20\%–80\%)}$

LOGIC DIAGRAM



DIP PIN ASSIGNMENT



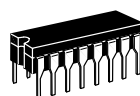
Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).



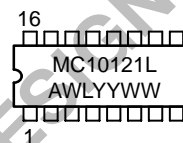
ON Semiconductor

<http://onsemi.com>

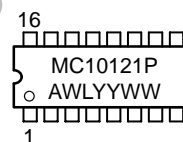
MARKING DIAGRAMS



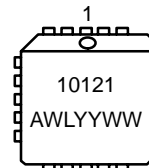
CDIP-16
L SUFFIX
CASE 620



PDIP-16
P SUFFIX
CASE 648



PLCC-20
FN SUFFIX
CASE 775



A = Assembly Location
 WL = Wafer Lot
 YY = Year
 WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10121L	CDIP-16	25 Units / Rail
MC10121P	PDIP-16	25 Units / Rail
MC10121FN	PLCC-20	46 Units / Rail

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I _E	8		29		20	26		29	mAdc	
Input Current	I _{inH}	7		390			245		245	μAdc	
		9		390			245		245		
		10		495			310		310		
	I _{inL}	7	0.5		0.5			0.3		μAdc	
		9	0.5		0.5			0.3			
		10	0.5		0.5			0.3			
Output Voltage	Logic 1	V _{OH}	3	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage	Logic 0	V _{OL}	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
		2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage	Logic 1	V _{OHA}	3	-1.080		-0.980			-0.910		Vdc
		2	-1.080			-0.980			-0.910		
Threshold Voltage	Logic 0	V _{OLA}	3		-1.655			-1.630		-1.595	Vdc
		2			-1.655			-1.630		-1.595	
Switching Times (50Ω Load)										ns	
Propagation Delay	t ₄₊₃₋	3	1.4	3.6	1.4	2.3	3.4	1.4	3.5		
	t ₄₋₃₊	3	1.4	3.6	1.4	2.3	3.4	1.4	3.5		
	t ₄₊₂₊	2	1.4	3.6	1.4	2.3	3.4	1.4	3.5		
	t ₄₋₂₋	2	1.4	3.6	1.4	2.3	3.4	1.4	3.5		
Rise Time (20 to 80%)	t ₃₊	3	0.9	4.1	1.1	2.5	4.0	1.1	4.6		
	t ₂₊	2	0.9	4.1	1.1	2.5	4.0	1.1	4.6		
Fall Time (20 to 80%)	t ₃₋	3	0.9	4.1	1.1	2.5	4.0	1.1	4.6		
	t ₂₋	2	0.9	4.1	1.1	2.5	4.0	1.1	4.6		

MC10121

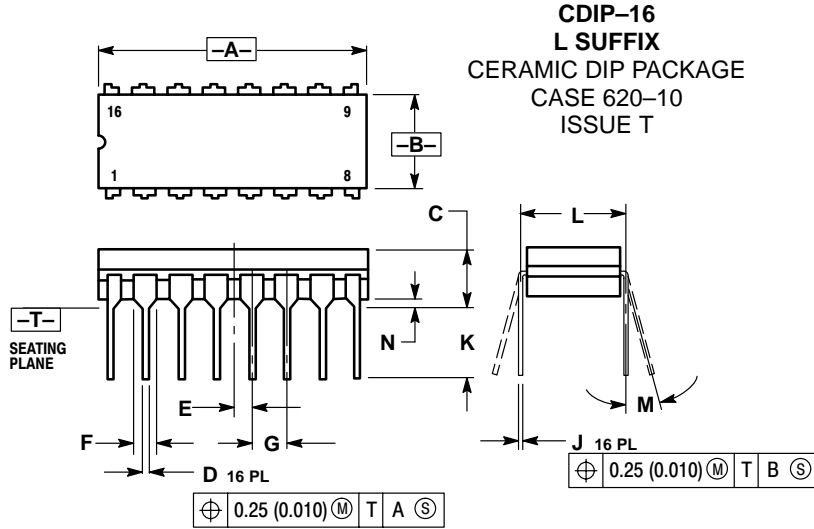
ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
			−0.890	−1.890	−1.205	−1.500	−5.2	
			+25°C	−0.810	−1.850	−1.105	−1.475	−5.2
			+85°C	−0.700	−1.825	−1.035	−1.440	−5.2
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
Power Supply Drain Current	I _E	8					8	1, 16
Input Current	I _{inH}	7	7				8	1, 16
		9	9				8	1, 16
		10	10				8	1, 16
	I _{inL}	7		7			8	1, 16
		9		9			8	1, 16
		10		10			8	1, 16
Output Voltage	Logic 1	V _{OH}	3				8	1, 16
		2	4, 10, 13				8	1, 16
Output Voltage	Logic 0	V _{OL}	3	4, 10, 13			8	1, 16
		2					8	1, 16
Threshold Voltage	Logic 1	V _{OHA}	3			4	8	1, 16
		2	10, 13		4		8	1, 16
Threshold Voltage	Logic 0	V _{OLA}	3		4		8	1, 16
		2	10, 13			4	8	1, 16
Switching Times (50Ω Load)			+1.11V		Pulse In	Pulse Out	−3.2 V	+2.0 V
Propagation Delay	t _{4+3−}	3	10, 13		4	3	8	1, 16
	t _{4−3+}	3	10, 13		4	3	8	1, 16
	t ₄₊₂₊	2	10, 13		4	2	8	1, 16
	t _{4−2−}	2	10, 13		4	2	8	1, 16
Rise Time (20 to 80%)	t ₃₊	3	10, 13		4	3	8	1, 16
	t ₂₊	2	10, 13		4	2	8	1, 16
Fall Time (20 to 80%)	t _{3−}	3	10, 13		4	3	8	1, 16
	t _{2−}	2	10, 13		4	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to −2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

MC10121

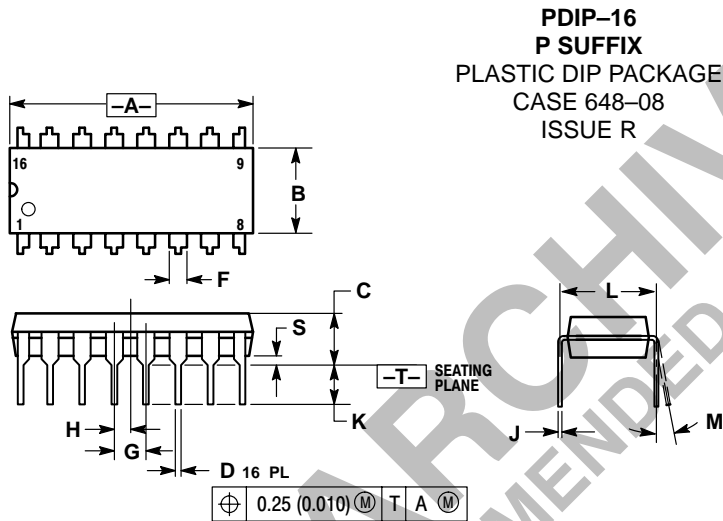
PACKAGE DIMENSIONS



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01


Notes

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Notes

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